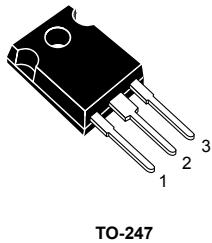
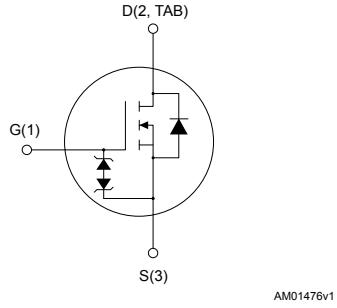


## N-channel 600 V, 0.175 Ω typ., 18 A MDmesh™ M2 EP Power MOSFET in a TO-247 package

### Features



| Order code   | V <sub>DS</sub> @ T <sub>Jmax</sub> | R <sub>DS(on)</sub> max. | I <sub>D</sub> |
|--|-------------------------------------|--------------------------|----------------|
| STW25N60M2-EP  | 650 V                               | 0.188 Ω                  | 18 A           |
| • Extremely low gate charge                                |                                     |                          |                |
| • Excellent output capacitance (C <sub>oss</sub> ) profile |                                     |                          |                |
| • Very low turn-off switching losses                       |                                     |                          |                |
| • 100% avalanche tested                                    |                                     |                          |                |
| • Zener-protected  |                                     |                          |                |



### Applications

- Switching applications
- Tailored for Very high frequency converters ( $f > 150$  kHz)

### Description

This device is an N-channel Power MOSFET developed using MDmesh™ M2 enhanced performance (EP) technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance, optimized switching characteristics with very low turn-off switching losses, rendering it suitable for the most demanding very high frequency converters.

| Product status link           |  |
|-------------------------------|--|
| <a href="#">STW25N60M2-EP</a> |  |
| Product summary               |  |
|                               |  |
| Order code                    |  |
| STW25N60M2-EP                 |  |
| Marking                       |  |
| 25N60M2EP                     |  |
| Package                       |  |
| TO-247                        |  |
| Packing                       |  |
| Tube                          |  |

## 1 Electrical ratings

Table 1. Absolute maximum ratings

| Symbol         | Parameter   | Value       | Unit             |
|----------------|---|-------------|------------------|
| $V_{GS}$       | Gate-source voltage                                     | $\pm 25$    | V                |
| $I_D$          | Drain current (continuous) at $T_C = 25^\circ\text{C}$  | 18          | A                |
| $I_D$          | Drain current (continuous) at $T_C = 100^\circ\text{C}$ | 11.3        | A                |
| $I_{DM}^{(1)}$ | Drain current (pulsed)                                  | 72          | A                |
| $P_{TOT}$      | Total dissipation at $T_C = 25^\circ\text{C}$           | 150         | W                |
| $dv/dt^{(2)}$  | Peak diode recovery voltage slope                       | 15          | V/ns             |
| $dv/dt^{(3)}$  | MOSFET $dv/dt$ ruggedness                               | 50          | V/ns             |
| $T_{stg}$      | Storage temperature range                               | - 55 to 150 | $^\circ\text{C}$ |
| $T_j$          | Operating junction temperature range                    |             |                  |

1. Pulse width limited by safe operating area.
2.  $I_{SD} \leq 18 \text{ A}$ ,  $di/dt \leq 400 \text{ A}/\mu\text{s}$ ,  $V_{DS \text{ peak}} < V_{(BR)DSS}$ ,  $V_{DD} = 400 \text{ V}$ .
3.  $V_{DS} \leq 480 \text{ V}$

Table 2. Thermal data

| Symbol         | Parameter                           | Value | Unit                      |
|----------------|-------------------------------------|-------|---------------------------|
| $R_{thj-case}$ | Thermal resistance junction-case    | 0.83  | $^\circ\text{C}/\text{W}$ |
| $R_{thj-amb}$  | Thermal resistance junction-ambient | 50    | $^\circ\text{C}/\text{W}$ |

Table 3. Avalanche characteristics

| Symbol   | Parameter   | Value | Unit |
|----------|---|-------|------|
| $I_{AR}$ | Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax}$ )                          | 3.5   | A    |
| $E_{AS}$ | Single pulse avalanche energy (starting $T_j = 25^\circ\text{C}$ , $I_D = I_{AR}$ , $V_{DD} = 50 \text{ V}$ ) | 200   | mJ   |

## 2 Electrical characteristics

$T_C = 25^\circ\text{C}$  unless otherwise specified

**Table 4. On/off states**

| Symbol                      | Parameter                         | Test conditions   | Min. | Typ.  | Max.     | Unit          |
|-----------------------------|-----------------------------------|---|------|-------|----------|---------------|
| $V_{(\text{BR})\text{DSS}}$ | Drain-source breakdown voltage    | $V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$                                    | 600  |       |          | V             |
| $I_{\text{DSS}}$            | Zero gate voltage drain current   | $V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}$                                |      |       | 1        | $\mu\text{A}$ |
|                             |                                   | $V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}, T_C = 125^\circ\text{C}^{(1)}$ |      |       | 100      | $\mu\text{A}$ |
| $I_{\text{GSS}}$            | Gate-body leakage current         | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$                             |      |       | $\pm 10$ | $\mu\text{A}$ |
| $V_{GS(\text{th})}$         | Gate threshold voltage            | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$                                      | 3.25 | 4     | 4.75     | V             |
| $R_{\text{DS(on)}}$         | Static drain-source on-resistance | $V_{GS} = 10 \text{ V}, I_D = 9 \text{ A}$                                    |      | 0.175 | 0.188    | $\Omega$      |

1. Defined by design, not subject to production test.

**Table 5. Dynamic**

| Symbol                     | Parameter                     | Test conditions   | Min. | Typ. | Max. | Unit     |
|----------------------------|-------------------------------|---|------|------|------|----------|
| $C_{\text{iss}}$           | Input capacitance             |   | -    | 1090 | -    | pF       |
| $C_{\text{oss}}$           | Output capacitance            | $V_{DS} = 100 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$                 | -    | 56   | -    | pF       |
| $C_{\text{rss}}$           | Reverse transfer capacitance  |   | -    | 1.6  | -    | pF       |
| $C_{\text{oss eq.}}^{(1)}$ | Equivalent output capacitance | $V_{DS} = 0 \text{ to } 480 \text{ V}, V_{GS} = 0 \text{ V}$                      | -    | 255  | -    | pF       |
| $R_G$                      | Intrinsic gate resistance     | $f = 1 \text{ MHz}, I_D = 0 \text{ A}$  | -    | 7    | -    | $\Omega$ |
| $Q_g$                      | Total gate charge             | $V_{DD} = 480 \text{ V}, I_D = 18 \text{ A}, V_{GS} = 0 \text{ to } 10 \text{ V}$ | -    | 29   | -    | nC       |
| $Q_{gs}$                   | Gate-source charge            |   | -    | 6    | -    | nC       |
| $Q_{gd}$                   | Gate-drain charge             | (see Figure 15. Test circuit for gate charge behavior)                            | -    | 12   | -    | nC       |

1.  $C_{\text{oss eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{\text{oss}}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

**Table 6. Switching energy**

| Symbol             | Parameter   | Test conditions  | Min. | Typ. | Max. | Unit          |
|--------------------|---|--|------|------|------|---------------|
| $E_{(\text{off})}$ | Turn-off energy<br>(from 90% $V_{GS}$ to 0% $I_D$ ) | $V_{DD} = 400 \text{ V}, I_D = 2 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ | -    | 7    | -    | $\mu\text{J}$ |
|                    |   | $V_{DD} = 400 \text{ V}, I_D = 4 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ | -    | 8    | -    | $\mu\text{J}$ |

**Table 7. Switching times**

| Symbol       | Parameter           | Test conditions   | Min. | Typ. | Max. | Unit |
|--------------|---------------------|---|------|------|------|------|
| $t_{d(on)}$  | Turn-on delay time  | $V_{DD} = 300 \text{ V}$ , $I_D = 9 \text{ A}$ ,<br>$R_G = 4.7 \Omega$ , $V_{GS} = 10 \text{ V}$<br>(see Figure 14. Test circuit for resistive load switching times and Figure 19. Switching time waveform) | -    | 15   | -    | ns   |
| $t_r$        | Rise time           |   | -    | 10   | -    | ns   |
| $t_{d(off)}$ | Turn-off delay time |   | -    | 61   | -    | ns   |
| $t_f$        | Fall time           |   | -    | 16   | -    | ns   |

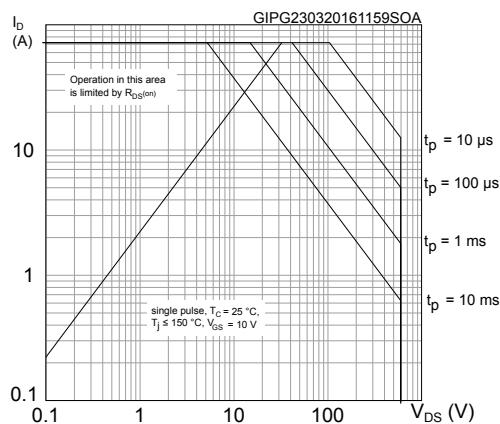
**Table 8. Source drain diode**

| Symbol          | Parameter                     | Test conditions  | Min. | Typ. | Max. | Unit          |
|-----------------|-------------------------------|--|------|------|------|---------------|
| $I_{SD}$        | Source-drain current          |  | -    |      | 18   | A             |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) |  | -    |      | 72   | A             |
| $V_{SD}^{(2)}$  | Forward on voltage            | $V_{GS} = 0 \text{ V}$ , $I_{SD} = 18 \text{ A}$   | -    |      | 1.6  | V             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 18 \text{ A}$ , $di/dt = 100 \text{ A}/\mu\text{s}$ ,<br>$V_{DD} = 100 \text{ V}$ (see Figure 16. Test circuit for inductive load switching and diode recovery times)                                | -    | 360  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       | $I_{SD} = 18 \text{ A}$ , $di/dt = 100 \text{ A}/\mu\text{s}$ ,<br>$V_{DD} = 100 \text{ V}$ , $T_j = 150^\circ\text{C}$<br>(see Figure 16. Test circuit for inductive load switching and diode recovery times) | -    | 5    |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |  | -    | 28   |      | A             |
| $t_{rr}$        | Reverse recovery time         |  | -    | 445  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       |  | -    | 6.5  |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |  | -    | 29   |      | A             |

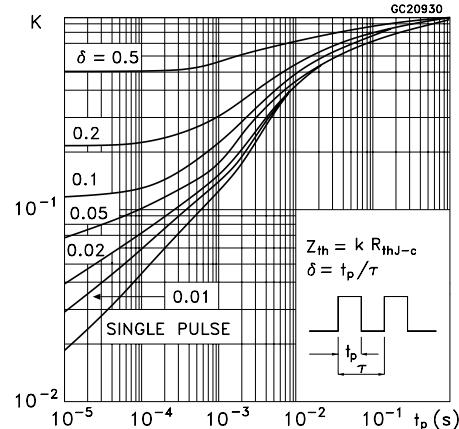
1. Pulse width is limited by safe operating area
2. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

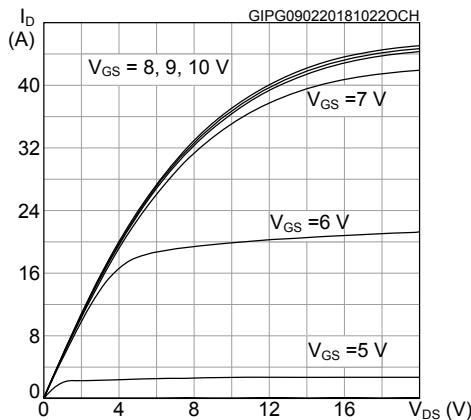
**Figure 1. Safe operating area**



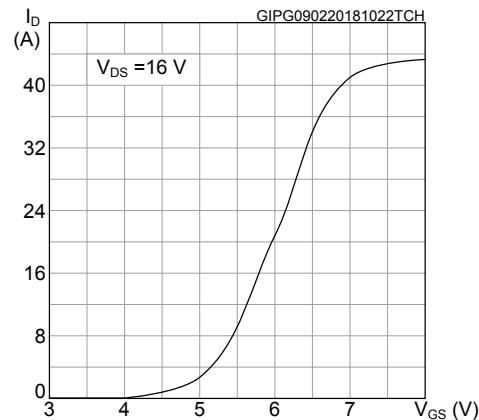
**Figure 2. Thermal impedance**



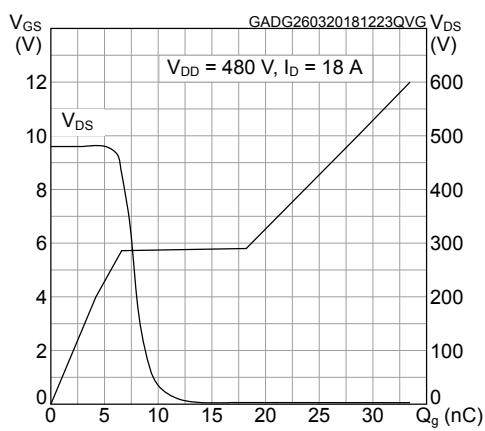
**Figure 3. Output characteristics**



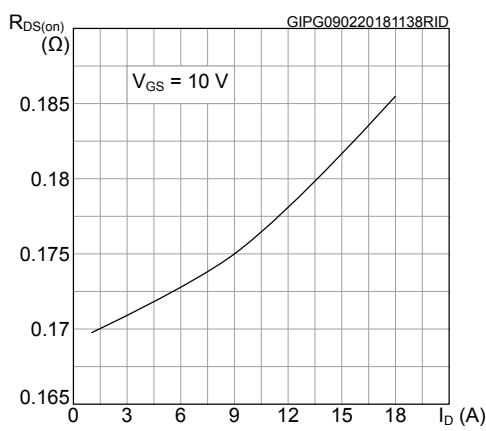
**Figure 4. Transfer characteristics**

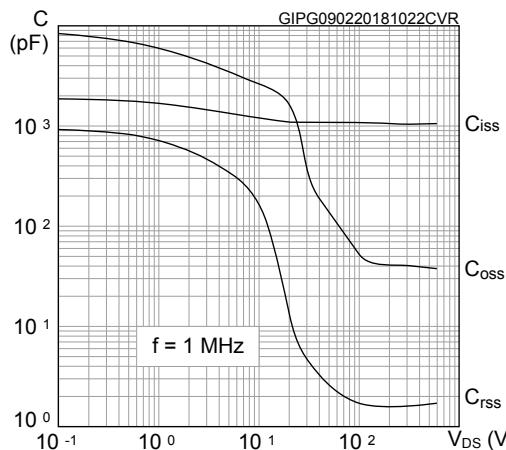
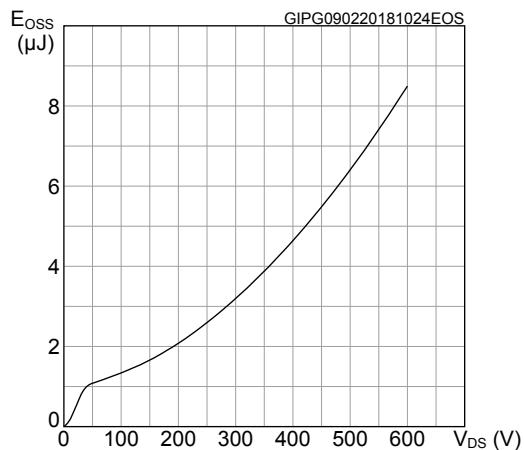
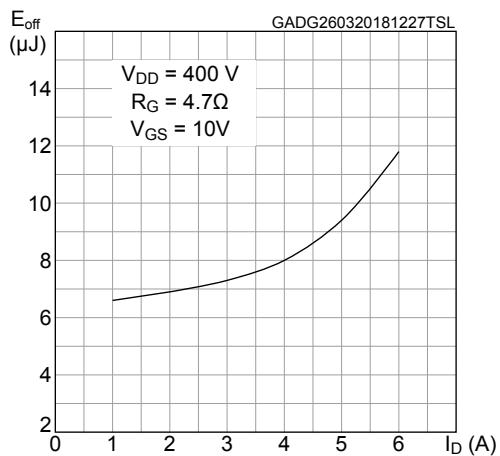
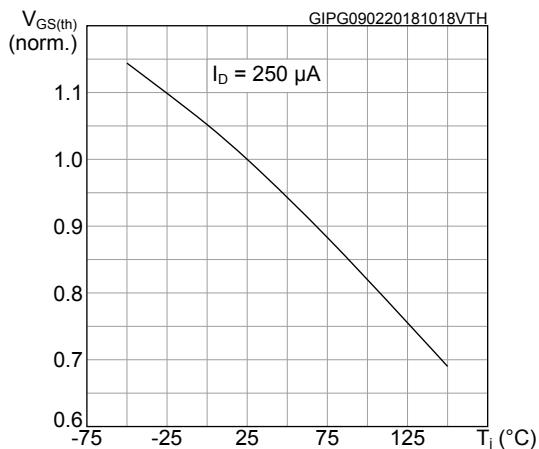
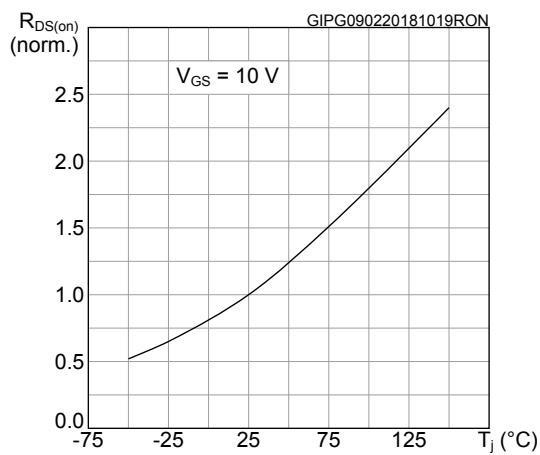
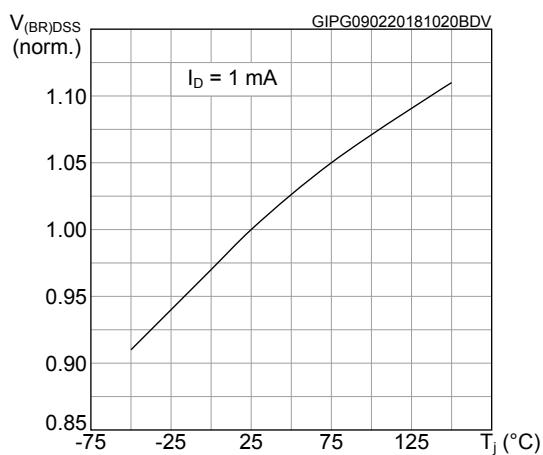


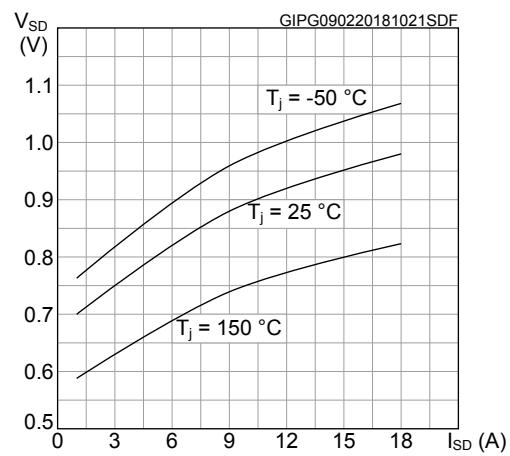
**Figure 5. Gate charge vs gate-source voltage**



**Figure 6. Static drain-source on-resistance**

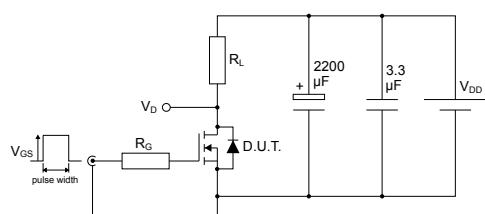


**Figure 7. Capacitance variations**

**Figure 8. Output capacitance stored energy**

**Figure 9. Turn-off switching energy vs drain current**

**Figure 10. Normalized gate threshold voltage vs temperature**

**Figure 11. Normalized on-resistance vs temperature**

**Figure 12. Normalized V\_(BR)DSS vs temperature**


**Figure 13. Source-drain diode forward characteristics**

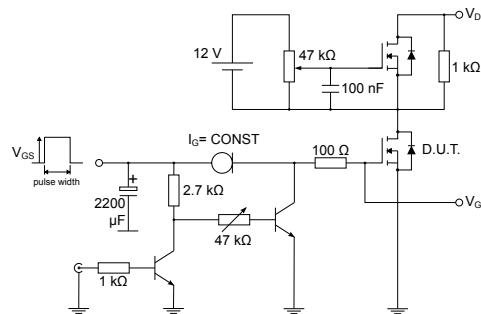
### 3 Test circuits

**Figure 14. Test circuit for resistive load switching times**



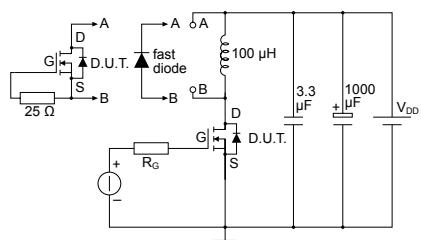
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**Figure 15. Test circuit for gate charge behavior**



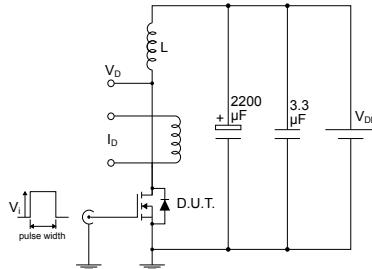
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**Figure 16. Test circuit for inductive load switching and diode recovery times**



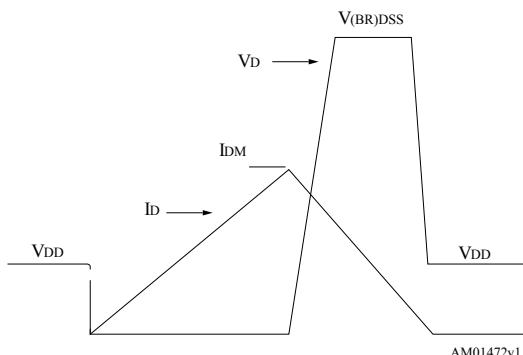
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**Figure 17. Unclamped inductive load test circuit**



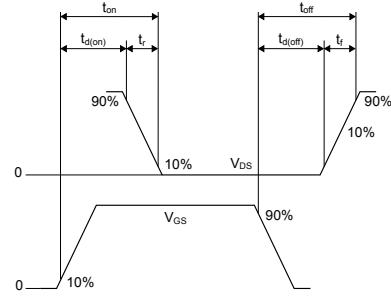
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**Figure 18. Unclamped inductive waveform**



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**Figure 19. Switching time waveform**



AM01473v1

**4**

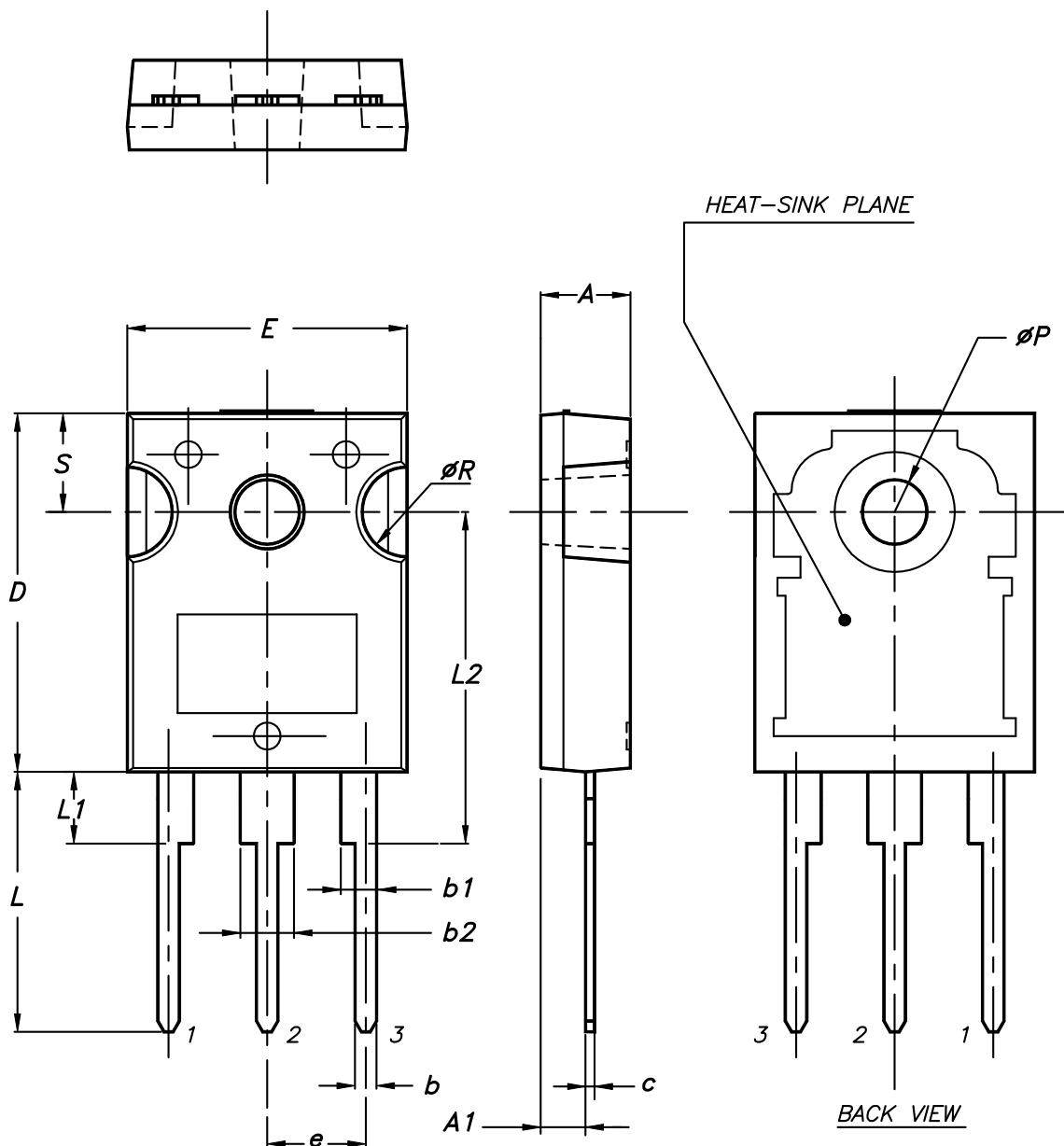
## Package information

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In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

## 4.1 TO-247 package information

Figure 20. TO-247 package outline



0075325\_9

**Table 9.** TO-247 package mechanical data

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 4.85  |       | 5.15  |
| A1   | 2.20  |       | 2.60  |
| b    | 1.0   |       | 1.40  |
| b1   | 2.0   |       | 2.40  |
| b2   | 3.0   |       | 3.40  |
| c    | 0.40  |       | 0.80  |
| D    | 19.85 |       | 20.15 |
| E    | 15.45 |       | 15.75 |
| e    | 5.30  | 5.45  | 5.60  |
| L    | 14.20 |       | 14.80 |
| L1   | 3.70  |       | 4.30  |
| L2   |       | 18.50 |       |
| ØP   | 3.55  |       | 3.65  |
| ØR   | 4.50  |       | 5.50  |
| S    | 5.30  | 5.50  | 5.70  |

## Revision history

**Table 10. Document revision history**

| Date        | Revision | Changes  |
|-------------|----------|--|
| 21-Mar-2016 | 1        | First release.   |
| 15-Feb-2018 | 2        | Removed maturity status indication from cover page.<br>Updated <i>Section 1 Electrical ratings</i> , <i>Section 2 Electrical characteristics</i> and <i>Section 2.1 Electrical characteristics (curves)</i> .<br>Minor text changes. |
| 28-May-2018 | 3        | Updated <a href="#">Table 1. Absolute maximum ratings</a> .<br>Updated <a href="#">Section 2 Electrical characteristics</a> and <a href="#">Section 2.1 Electrical characteristics (curves)</a> .<br>Minor text changes              |

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